

TERALINK™

**A cross-linked thermoplastic
polymer for Optical Components
that can withstand SMT processes**

**Sumitomo Electric Fine Polymer, Inc.
Innovation Core SEI, Inc. (ICS)
Sumitomo Electric Industries, Ltd.**

SEI's Five Business Domains



Automotive



Electronics



**Information
Communications**

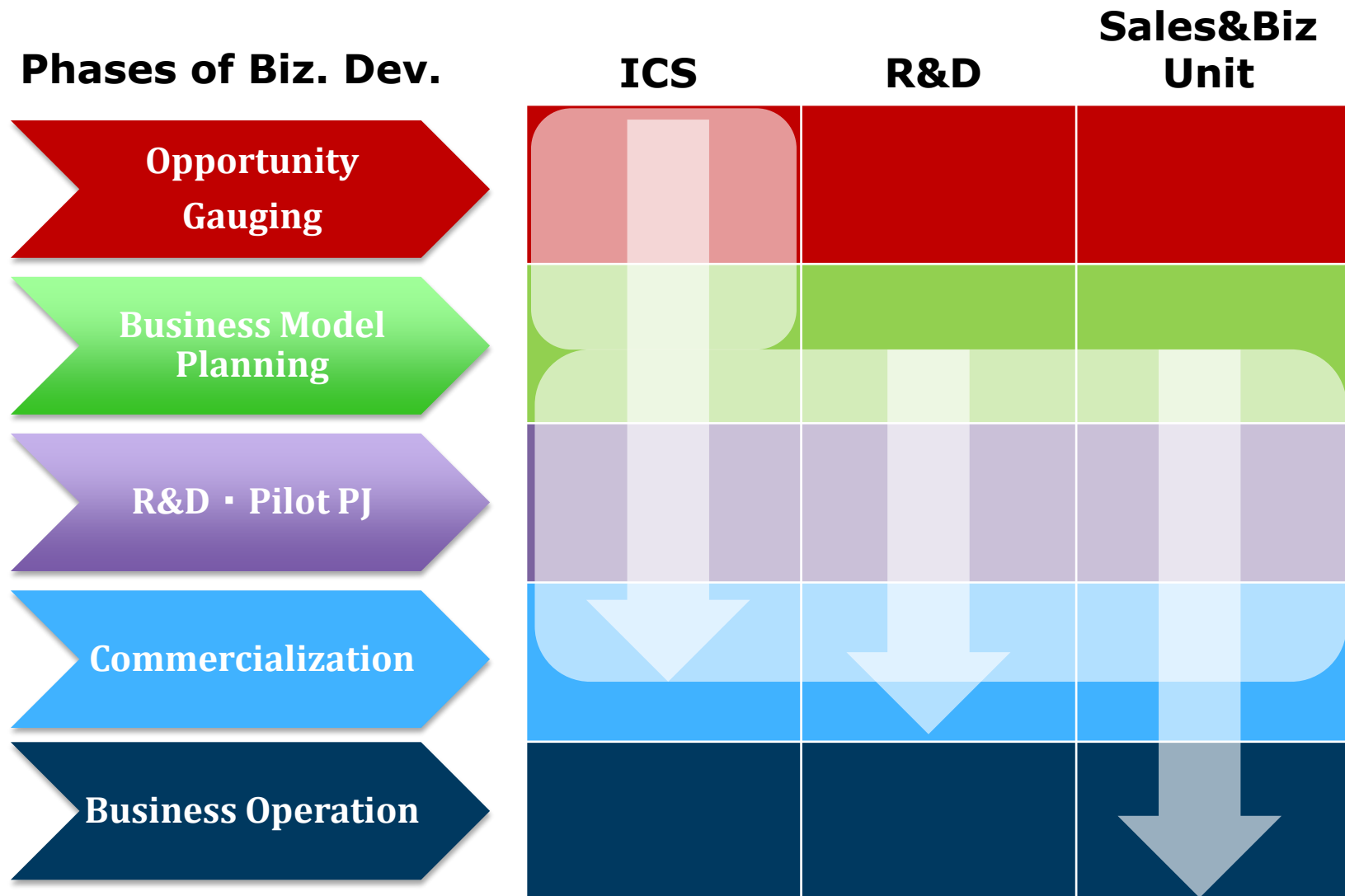


**Environment &
Energy**



**Industrial
Materials**

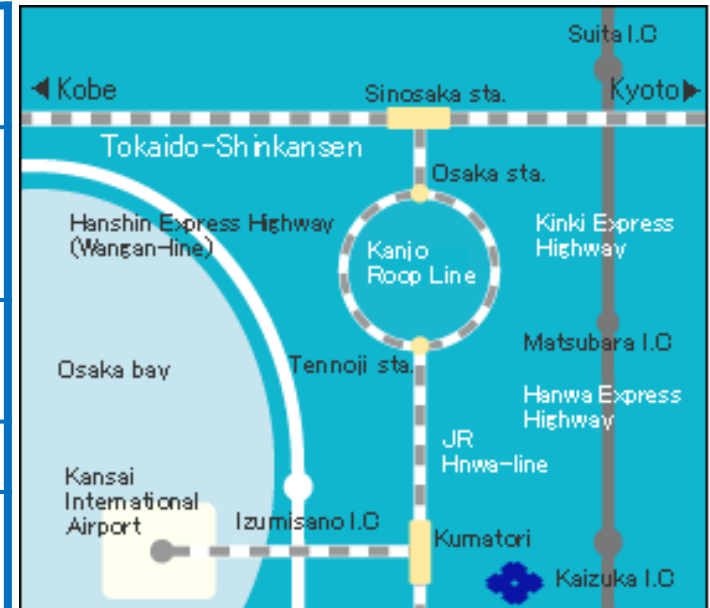
ICS Role: Creating New Biz. in North America



Company Profile

Sumitomo Electric Fine Polymer, Inc. is a wholly-owned subsidiary of Sumitomo Electric Industries, Ltd. We specialize in electron beam irradiation technology and fluororesin processing technology supplying unique products to a wide range of industries including automobiles, information and communications, home electronics and infrastructure.

Company Name	Sumitomo Electric Fine Polymer, Inc.
Address	1-950, Asashiro nishi, Kumatori-cho, Sennan-gun, Osaka, 590-0458 JAPAN TEL:+81-72-452-1301
Activities	Development and production of products made of fine polymer materials
Capital	10 billion yen
Number of employees	Approximately 480



Products

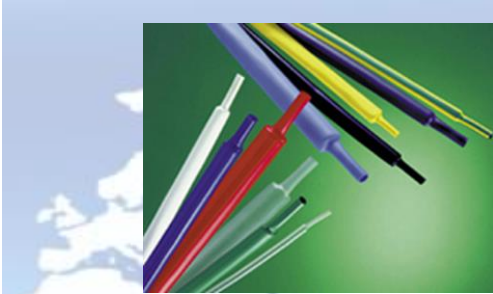


■ Irradiated Products

- Heat-shrinkable tubing and heat resistant tapes
- Thermoplastic polymer components (*TERALINK*)

■ Functional Fluororesin Products

- Fluororesin- coated aluminum products for cookers
- Rollers for ink-jet printers
- Porous materials made of PTFE for microfiltration



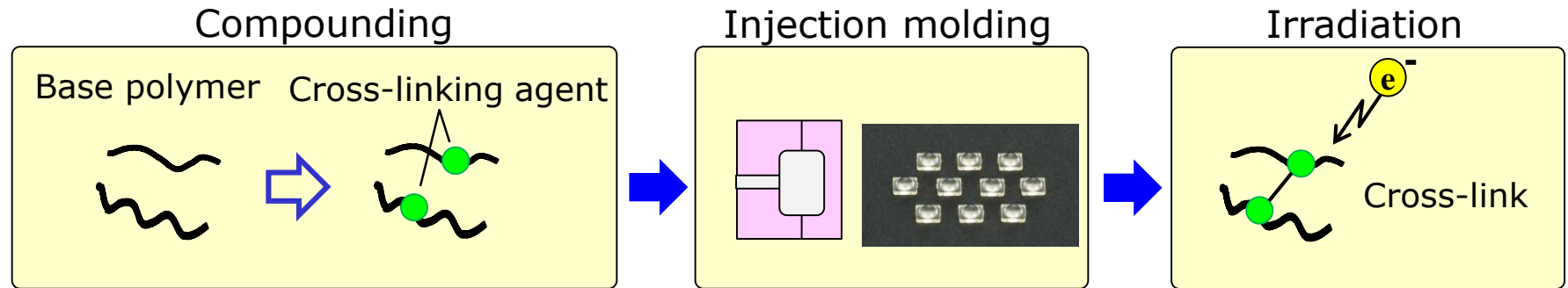
Irradiated Products



Functional Fluororesin Products

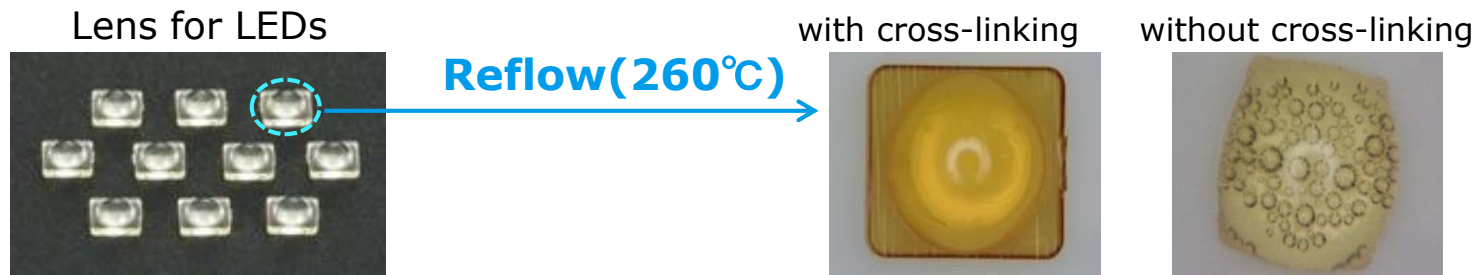
What is TERALINK?

■ Thermoplastic polymer cross-linked by electron-beam irradiation



■ Advantages

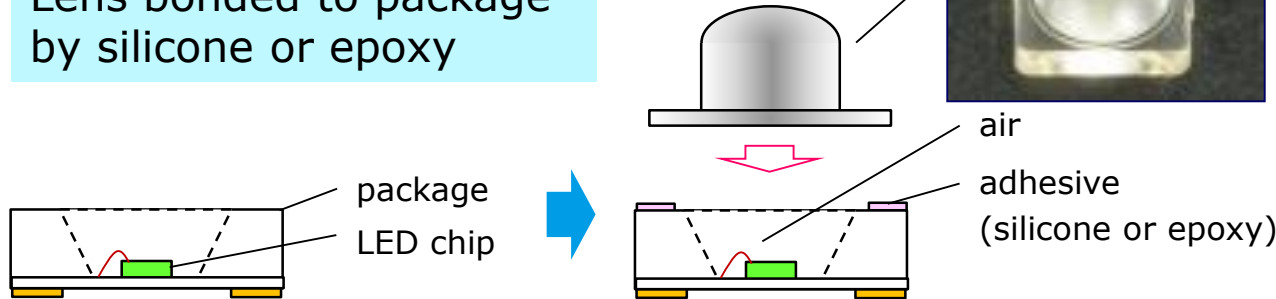
- Structurally stable at temperatures above melting point
- Retains original shape and transmittance under reflow process (260°C)
- Improved resistance to wear
- Improved resistance to chemicals



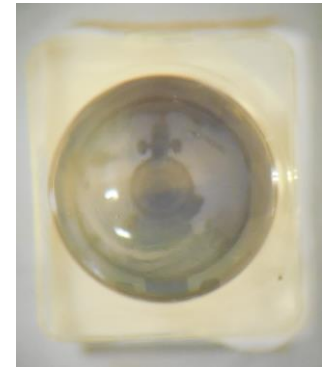
Application example: Lens for SMT LED packages

■ Lens for SMT LED packages

Lens bonded to package by silicone or epoxy



Top view of LED

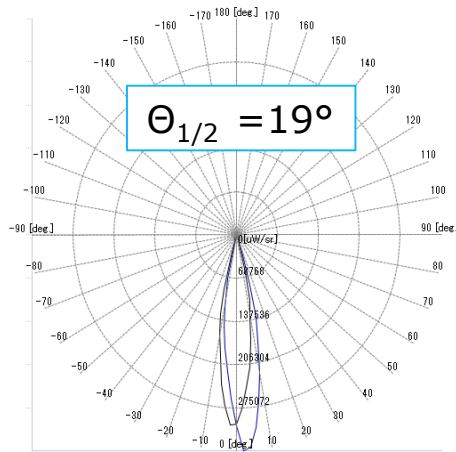
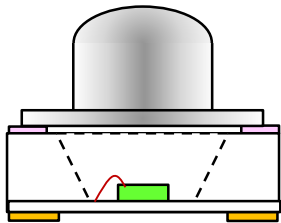


No deformation after reflow

■ Radiation characteristics

SMT LED with lens-bonded package

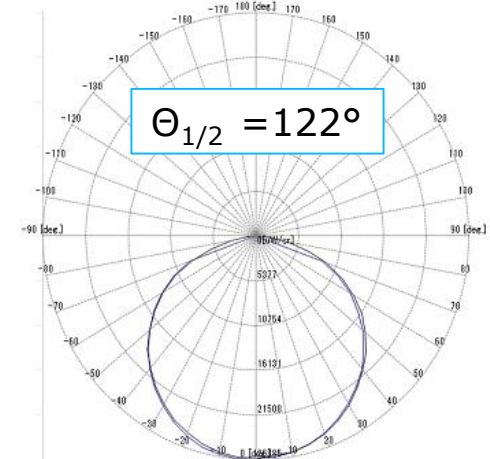
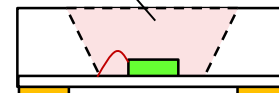
$$\begin{aligned} P_O &= 73\text{mW} \\ I_E &= 350\text{mW/sr} \\ I_F &= 120\text{mA} \end{aligned}$$



SMT LED without lens

$$\begin{aligned} P_O &= 84\text{mW} \\ I_E &= 270\text{mW/sr} \\ I_F &= 120\text{mA} \end{aligned}$$

silicone

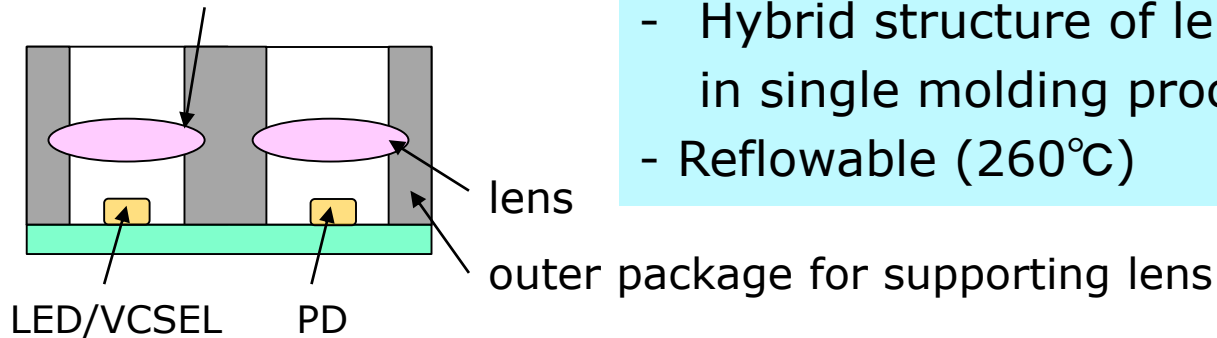


High power SMT LEDs with view angles $< 20^\circ$ realized by lens-bonded packages

Application example: Optical connectors

■ Lens for optical connectors

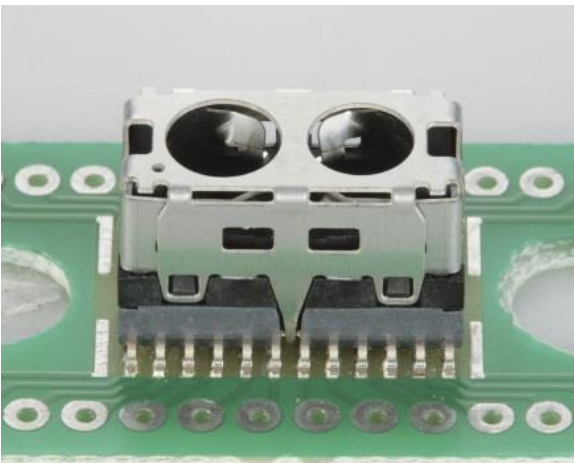
No need for adhesives



Features

- Hybrid structure of lens and housing realized in single molding process
- Reflowable (260°C)

Optical connector



<Prod.>

- Optical connectors (POF:650nm)

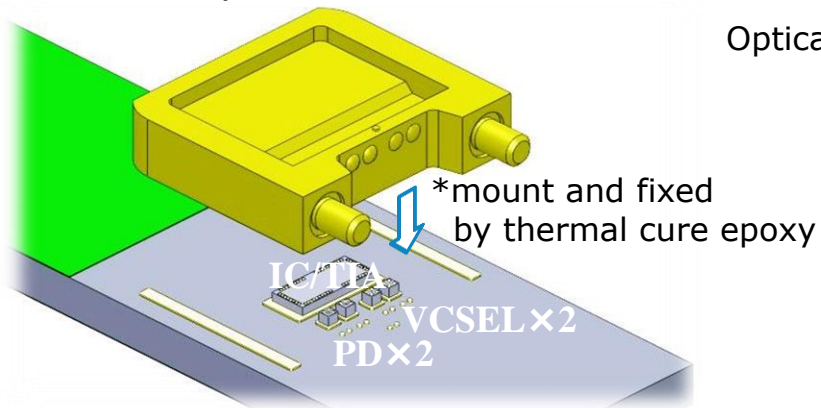
<R&D>

- Optical connectors (MMF:850nm)
- lens package for LEDs & PDs

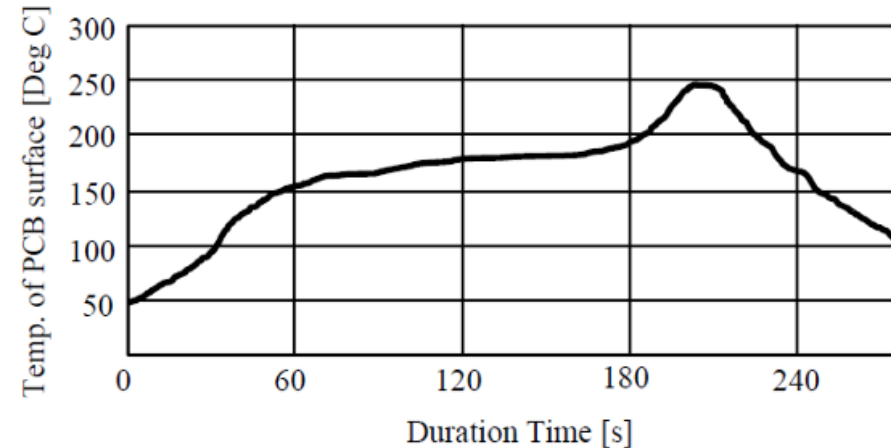
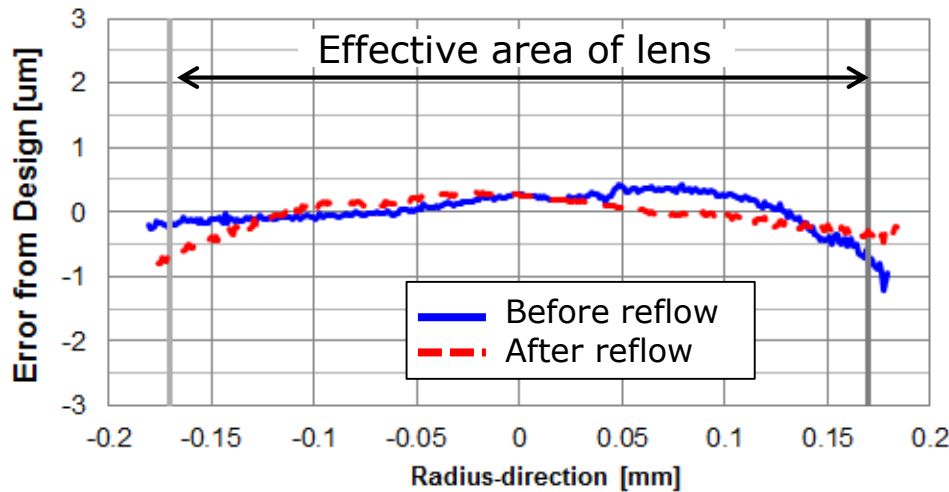
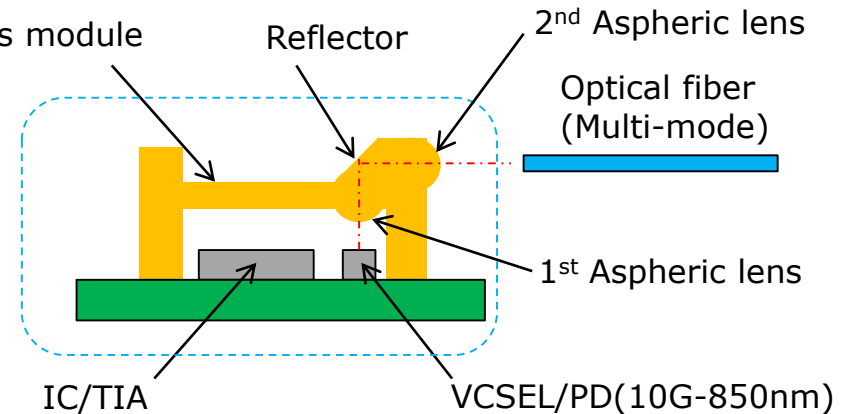
Application example: Optical lens module for VCSELs

10Gbit/s AOC lens module

Optical lens module

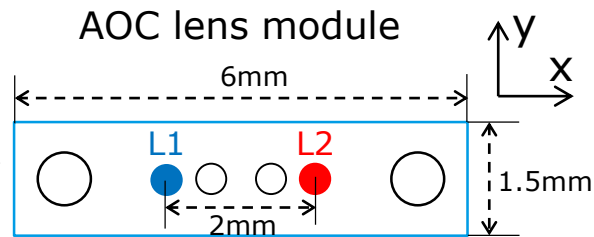
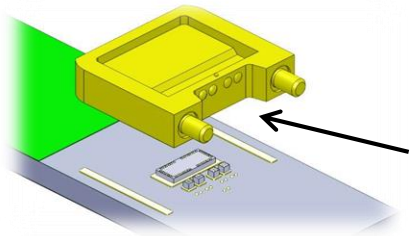


Optical lens module



Deformation of the lens surface profile after reflow is within 1~2 μ m

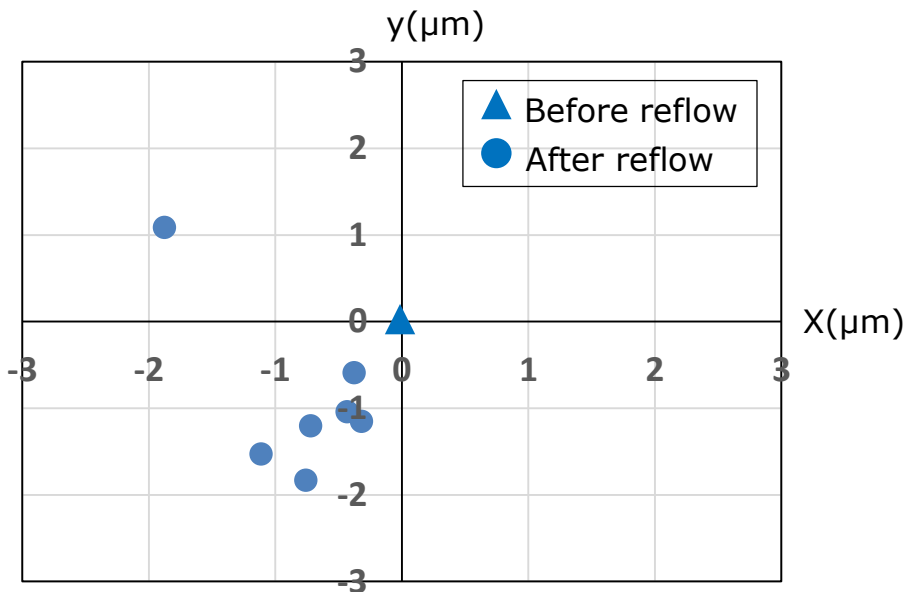
Shift in the lens position after reflow



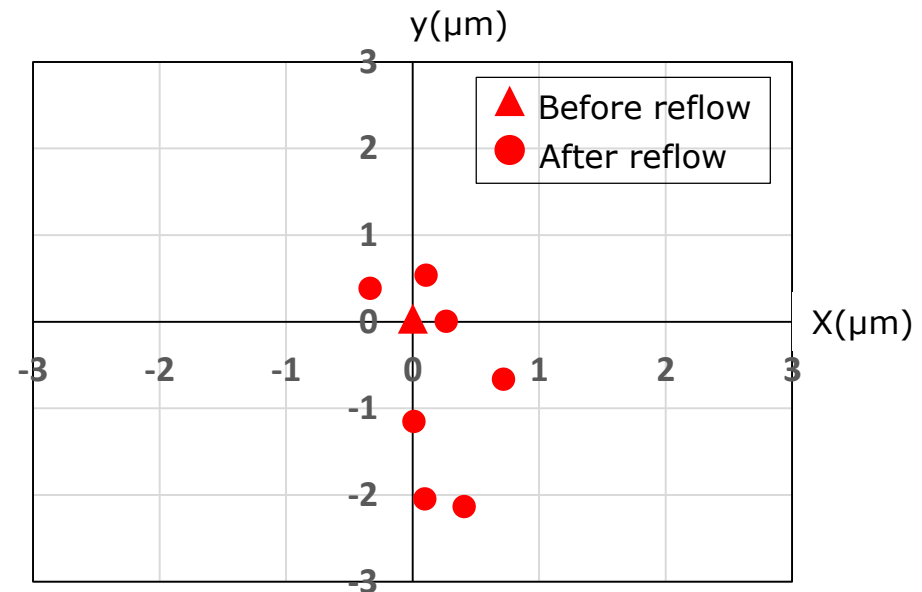
Test method

- Reflow performed on 7 samples
- Lens positions measured after reflow

L1 position

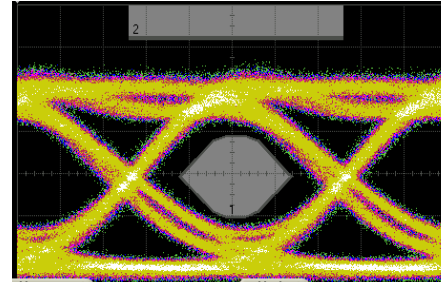
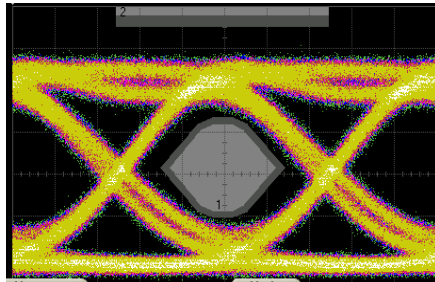


L2 position

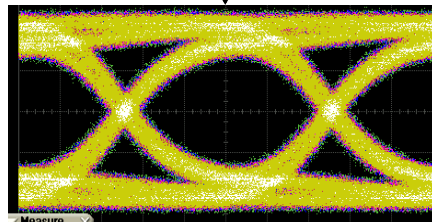
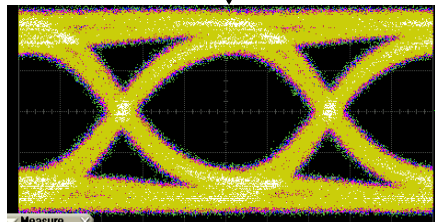
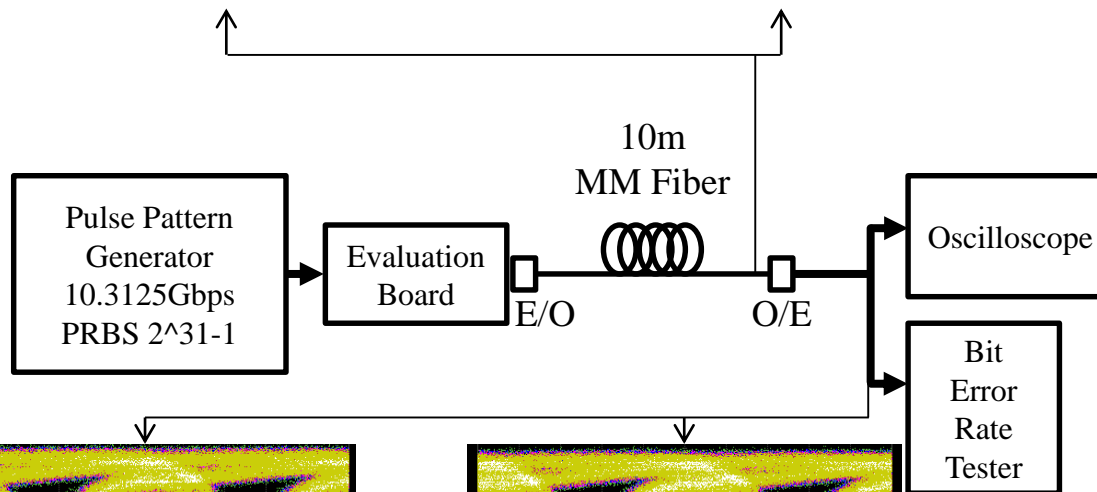


Shift in the L1, L2 positions after reflow is at most 2.1 μm

Demonstration of 10Gbits/s transmission



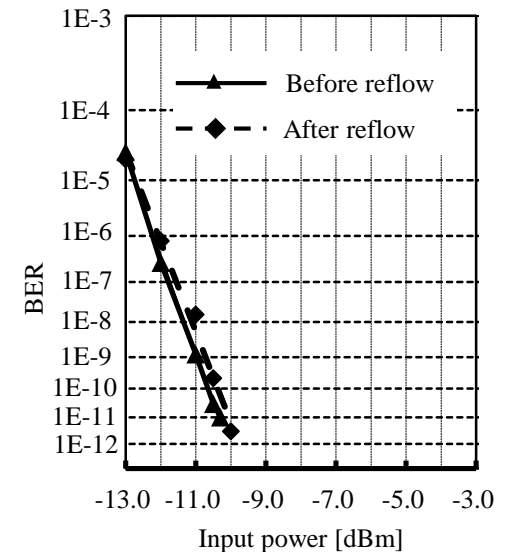
(a) Tx Optical waveform (Before Reflow) (b) Tx Optical waveform (After Reflow)



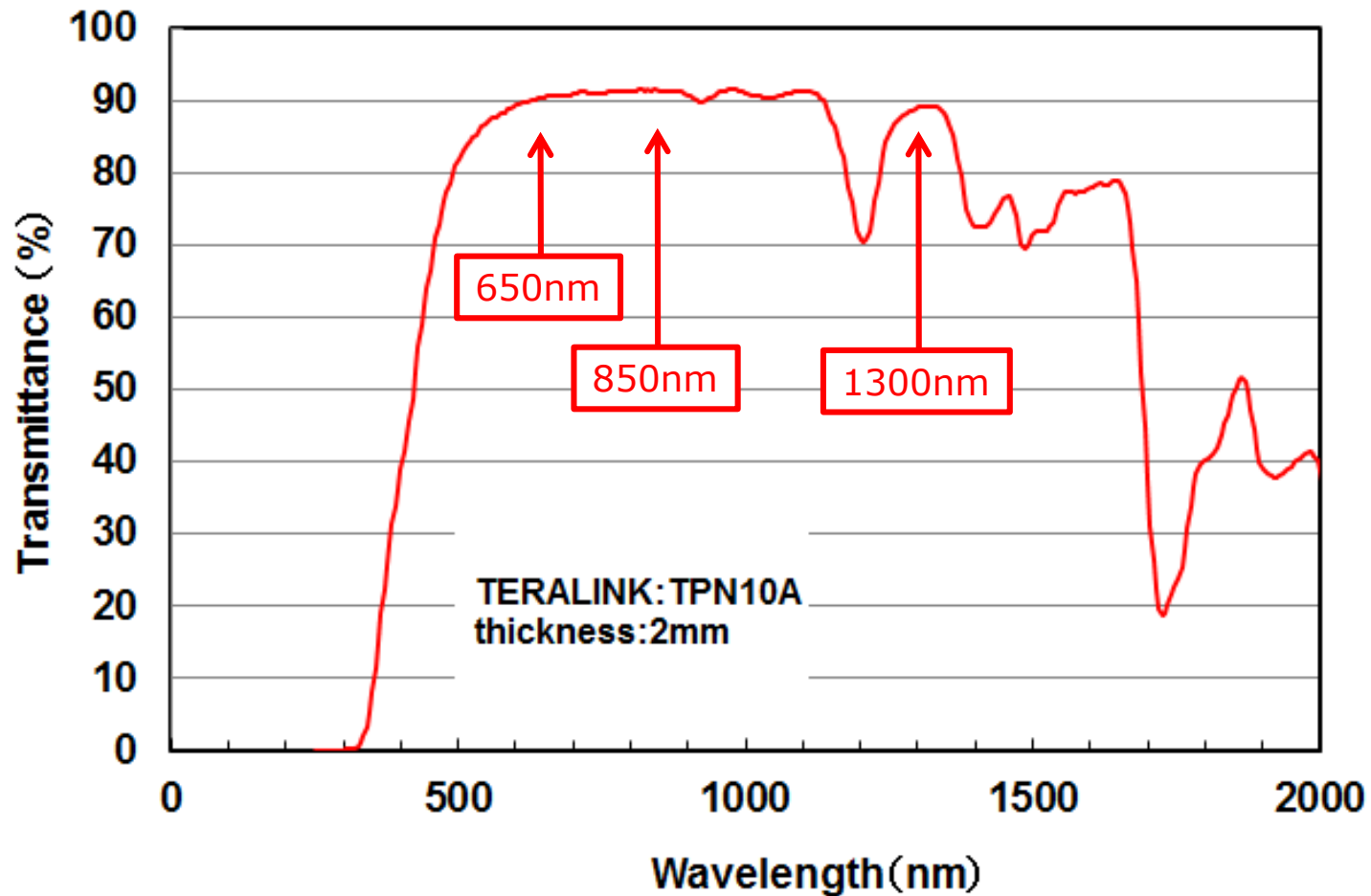
(C) Output waveform (Before Reflow) (D) Output waveform (After Reflow)

Error Free !

*both Before and After reflow

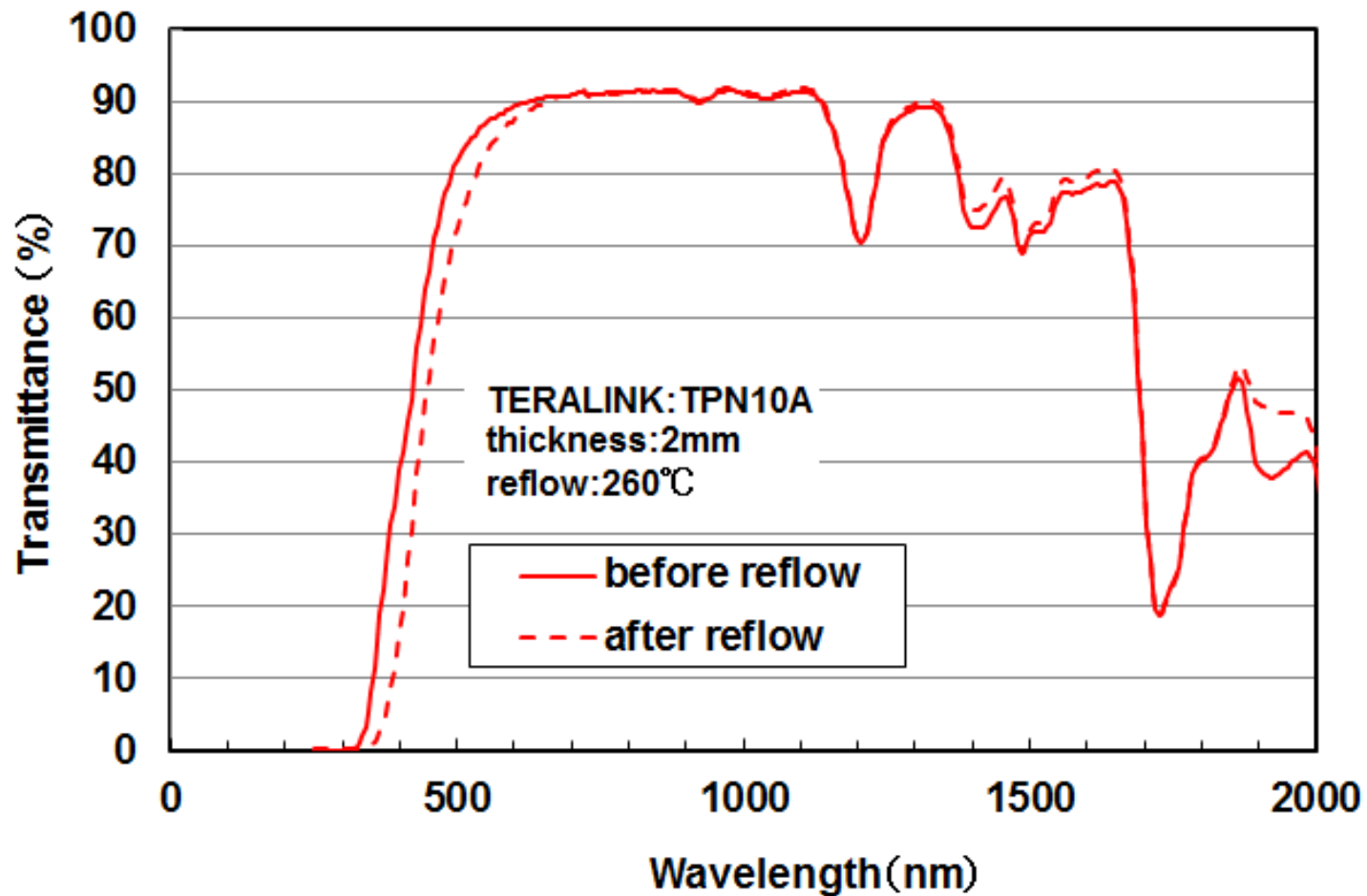


Transmittance spectrum



$T > 90\% @ 650 \sim 850\text{nm}$, $\sim 90\% @ 1300\text{nm}$, $75 \sim 80\% @ 1550\text{nm}$

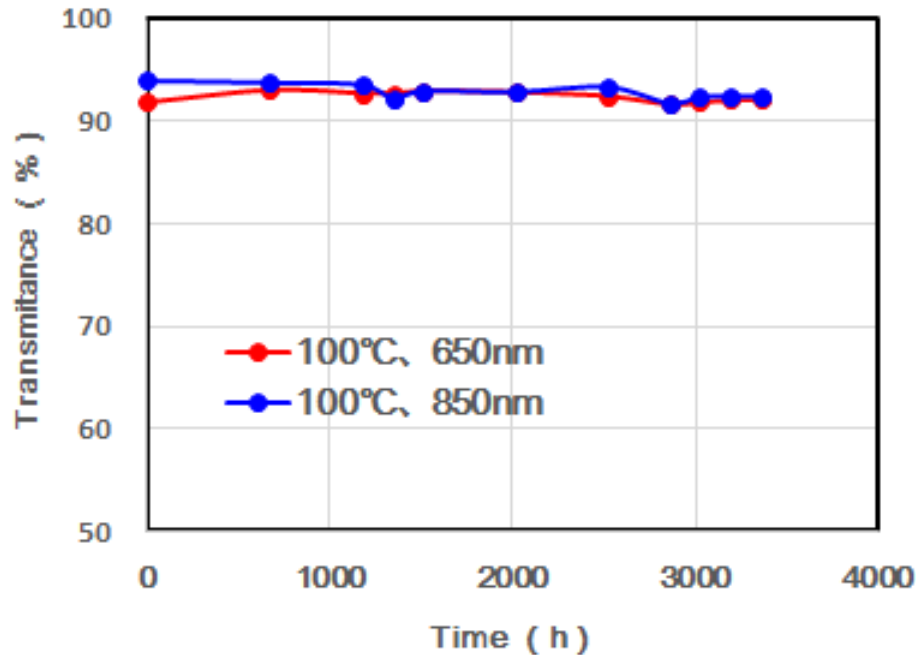
Effect of reflow on transmittance



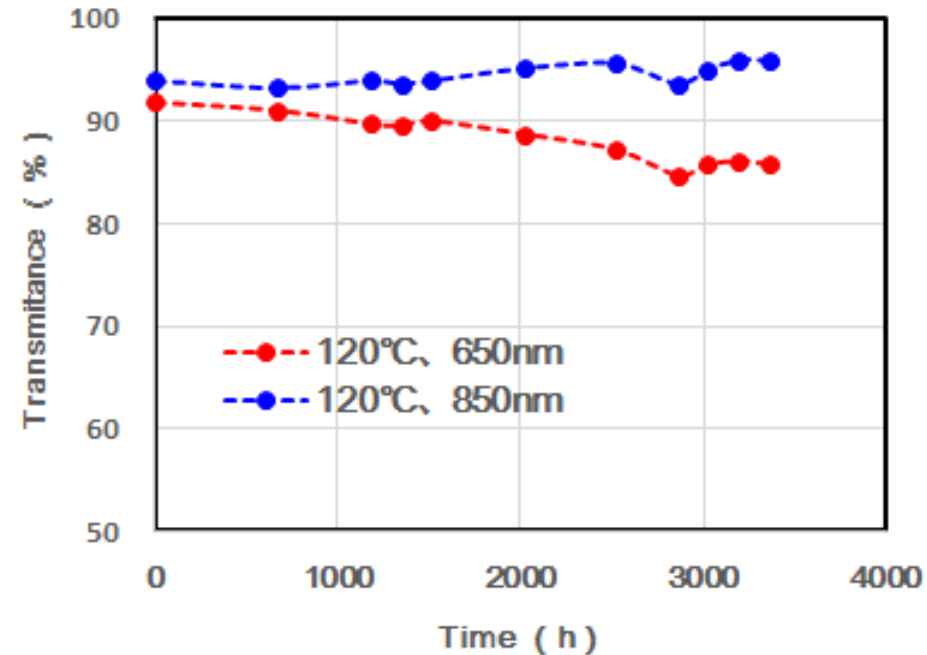
Transmittance spectrum remains virtually unchanged above 650nm

Reliability data on transmittance

Reliability at 100°C



Reliability at 120°C



650nm \Rightarrow no degradation observed up to 3300h at 100°C
850nm \Rightarrow no degradation observed up to 3300h at 120°C

Material properties

	Test method	Unit	TERALINK※1	PEI
Density	ISO1183	g/cm ³	1.0	1.3
Refractive index	JISK7142	—	1.51	1.64
Transmittance (2mm)	JISK7361	%	91	-
Transmittance (2mm, 650nm)	—	%	90	89
Transmittance (2mm, 850nm)	—	%	91	89
Haze	JISK7361	%	1.7	-
Glass transition temperature	ISO11357	°C	153※2	217
Tensile strength at break	ISO527	MPa	73	110
Elongation at break	ISO527	%	29	60
Bending strength	ISO178	MPa	100	165
Bending elastic modulus	ISO178	GPa	1.8	3.5
Charpy impact strength (notched)	ISO179	KJ/m ²	1.7	-
Water absorption (23°C/sat.)	ISO62	%	2.0	1.3
Water absorption (23°C/50%R.H.)	ISO62	%	1.0	-
Thermal expansion coefficient	ISO11359	10 ⁻⁴ /K	0.9	0.6
Flammability	UL94	—	HB	V0
Specific volume resistivity	IEC93	Ω · cm	1.00E+11	1.00E+17

※1 Grade:TPN10A

※2 Teralink does not melt and keeps its original shape above T_g

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Summary

- TERALINK is a cross-linked thermoplastic polymer for Optical Components that can withstand SMT processes
- Features
 - Reflowable (260°C)
 - Transmittance is over 90%(600nm~1100nm)
 - Injection molding applicable (cost effective, high flexibility in design)
 - Hybrid structures of lens & supporting holder realized in a single molding process
- Applications include
 - Lens for SMT-type LEDs or PDs
 - Lens package for optical connectors
 - Optical components for multi-mode fiber applications (VCSELs)
- We appreciate your feedback!

THANK YOU!

Sumitomo Electric Fine Polymer, Inc.
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